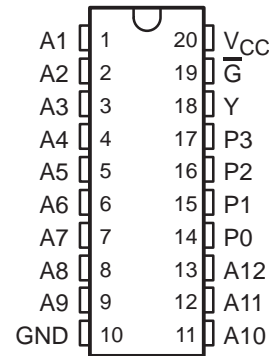


SN74ALS679 12-BIT ADDRESS COMPARATOR

SDAS003C – JUNE 1982 – REVISED JANUARY 1995

- 12-Bit Address Comparator With Enable
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

DW OR N PACKAGE
(TOP VIEW)



description

This 12-bit address comparator simplifies addressing of memory boards and/or other peripheral devices. The four P inputs are normally hardwired with a preprogrammed address. An internal decoder determines what input information applied to the A inputs must be low or high to cause a low state at the Y output. For example, a positive-logic bit combination of 0111 (decimal 7) at the P input determines that inputs A1 through A7 must be low and that inputs A8 through A12 must be high to cause the output to go low. Equality of the address applied at the A inputs to the preprogrammed address is indicated by the output being low.

This device features an enable (\bar{G}) input. When \bar{G} is low, the device is enabled. When \bar{G} is high, the device is disabled and the output is high, regardless of the A and P inputs.

The SN74ALS679 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE

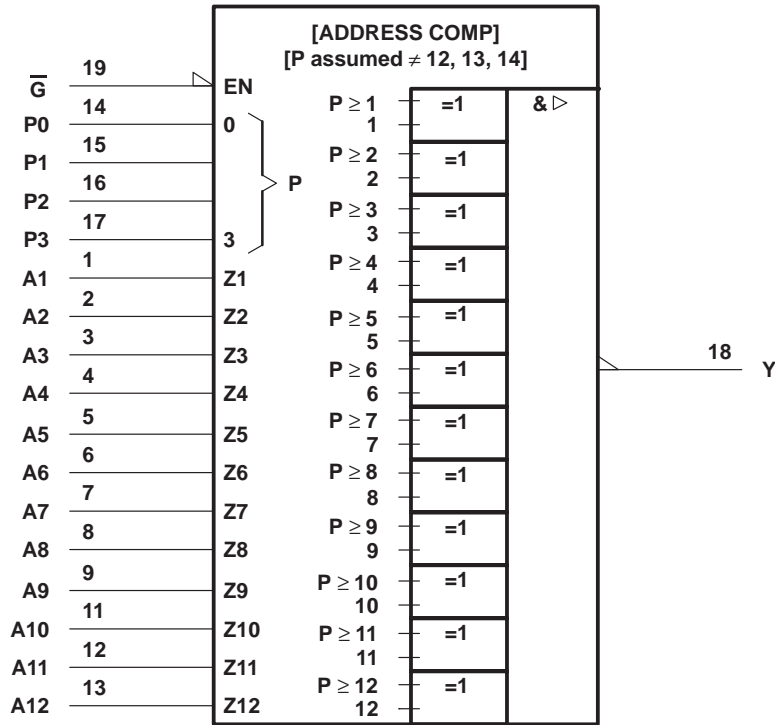
INPUTS																OUTPUT Y	
\bar{G}	P3	P2	P1	P0	A1	A2	A3	A4	A5	A6	A7	A8	A9	A10	A11		A12
L	L	L	L	L	H	H	H	H	H	H	H	H	H	H	H	H	L
L	L	L	L	H	L	H	H	H	H	H	H	H	H	H	H	H	L
L	L	L	H	L	L	L	H	H	H	H	H	H	H	H	H	H	L
L	L	L	H	H	L	L	L	H	H	H	H	H	H	H	H	H	L
L	L	H	L	L	L	L	L	H	H	H	H	H	H	H	H	H	L
L	L	H	L	H	L	L	L	L	H	H	H	H	H	H	H	H	L
L	L	H	H	L	L	L	L	L	L	L	L	L	H	H	H	L	L†
L	L	H	H	H	L	L	L	L	L	L	L	L	L	H	H	L	L†
L	L	H	H	H	L	L	L	L	L	L	L	L	L	L	H	L	L†
L	H	H	H	H	L	L	L	L	L	L	L	L	L	L	L	L	L
L	All other combinations																H
H	Any combination																H

† The three shaded rows of the function table show combinations that would normally not be used in address comparator applications. The logic symbols above are not valid for these combinations in which P = 12, 13, and 14. If symbols valid for all combinations are required, starting with the fourth exclusive-OR from the bottom, change P ≥ 9 to P = 9 . . . 11/13 . . . 15, P ≥ 10 to P = 10/11/14/15, and P ≥ 11 to P = 11/15.

SN74ALS679 12-BIT ADDRESS COMPARATOR

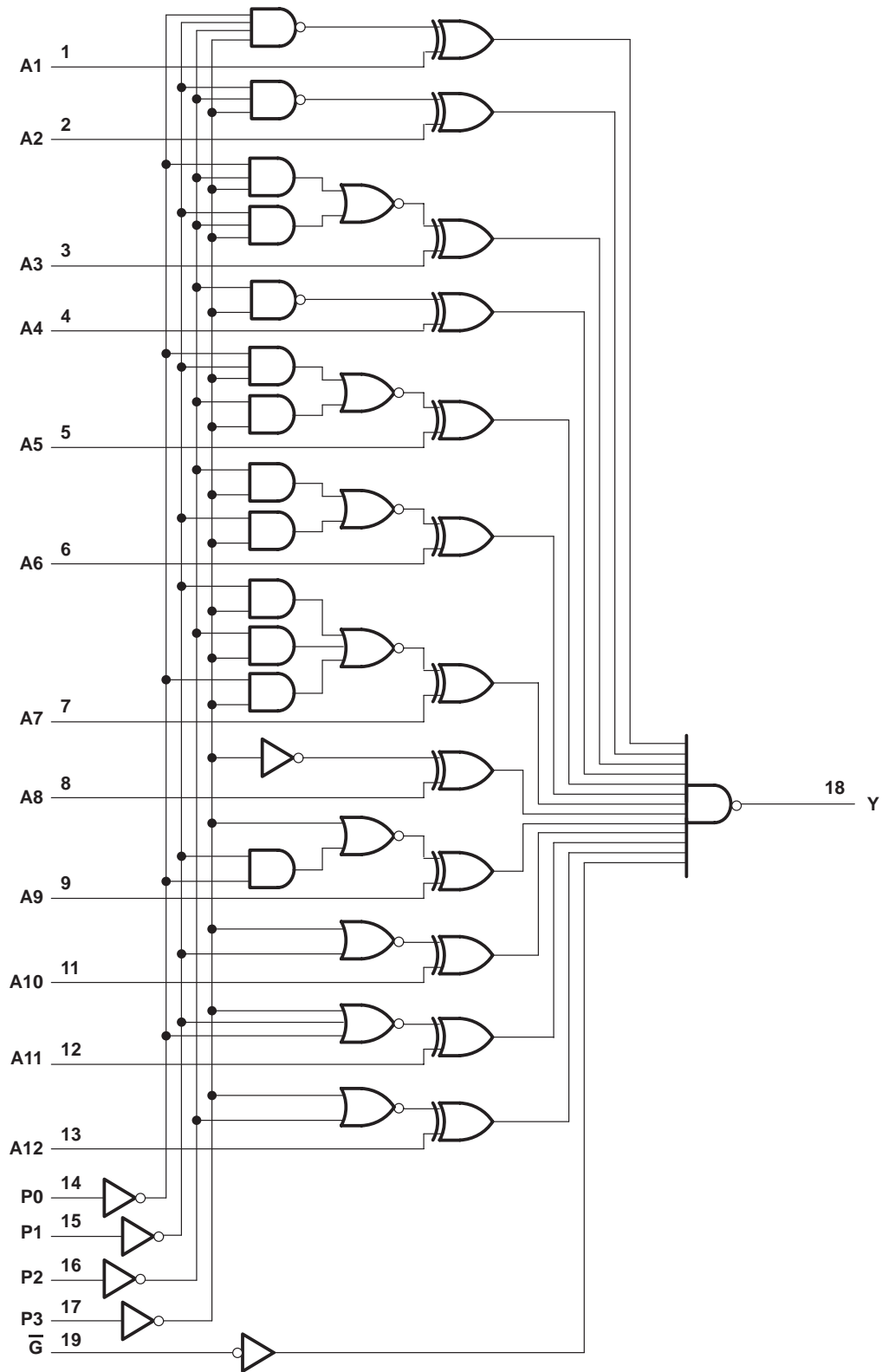
SDAS003C – JUNE 1982 – REVISED JANUARY 1995

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



SN74ALS679

12-BIT ADDRESS COMPARATOR

SDAS003C – JUNE 1982 – REVISED JANUARY 1995

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

	MIN	NOM	MAX	UNIT
V_{CC} Supply voltage	4.5	5	5.5	V
V_{IH} High-level input voltage	2			V
V_{IL} Low-level input voltage			0.8	V
I_{OH} High-level output current			-2.6	mA
I_{OL} Low-level output current			24	mA
T_A Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP‡	MAX	UNIT
V_{IK}	$V_{CC} = 4.5$ V, $I_I = -18$ mA			-1.5	V
V_{OH}	$V_{CC} = 4.5$ V to 5.5 V, $I_{OH} = -0.4$ mA	$V_{CC} - 2$			V
	$V_{CC} = 4.5$ V, $I_{OH} = -2.6$ mA	2.4	3.2		
V_{OL}	$V_{CC} = 4.5$ V		0.25	0.4	V
		$I_{OL} = 12$ mA			
			0.35	0.5	
I_I	$V_{CC} = 5.5$ V, $V_I = 7$ V			0.1	mA
I_{IH}	$V_{CC} = 5.5$ V, $V_I = 2.7$ V			20	μA
I_{IL}	$V_{CC} = 5.5$ V, $V_I = 0.4$ V			-0.1	mA
$I_{O§}$	$V_{CC} = 5.5$ V, $V_O = 2.25$ V	-30		-112	mA
I_{CC}	$V_{CC} = 5.5$ V		17	28	mA

‡ All typical values are at $V_{CC} = 5$ V, $T_A = 25$ °C.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

switching characteristics (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ V to 5.5 V, $C_L = 50$ pF, $R_L = 500$ Ω, $T_A = \text{MIN to MAX}^{\dagger\dagger}$		UNIT
			MIN	MAX	
t_{PLH}	Any P	Y	4	25	ns
t_{PHL}			8	35	
t_{PLH}	Any A	Y	5	22	ns
t_{PHL}			5	30	
t_{PLH}	\bar{G}	Y	3	13	ns
t_{PHL}			5	25	

†† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



APPLICATION INFORMATION

The SN74ALS679 can be wired to recognize any one of 2^{12} addresses. The number of lows in the address determines the input pattern for the P inputs. The system address lines that are low in the address to be recognized are connected to the lowest-numbered A inputs of the address comparator. The system address lines that are high are connected to the highest-numbered A inputs.

For example, assume the comparator is to enable a device when the 12-bit system address is:

A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
H	H	L	L	H	H	L	L	H	H	H	H

Because the address contains four lows and eight highs, the following connections are made:

- P3 to 0 V, P2 to V_{CC} , P1 to 0 V, and P0 to 0 V
- System address lines A9, A8, A5, and A4 to comparator inputs A1 through A4 in any convenient order
- The remaining eight system address lines to comparator inputs A5 through A12 in any convenient order

The output provides an active-low enabling signal.

Figure 1 is a register-bank decoder that examines the 14 most significant bits (A0 through A13) of a 20-bit address to select banks corresponding to the hex addresses 10000, 10040, 10080, and 100C0.

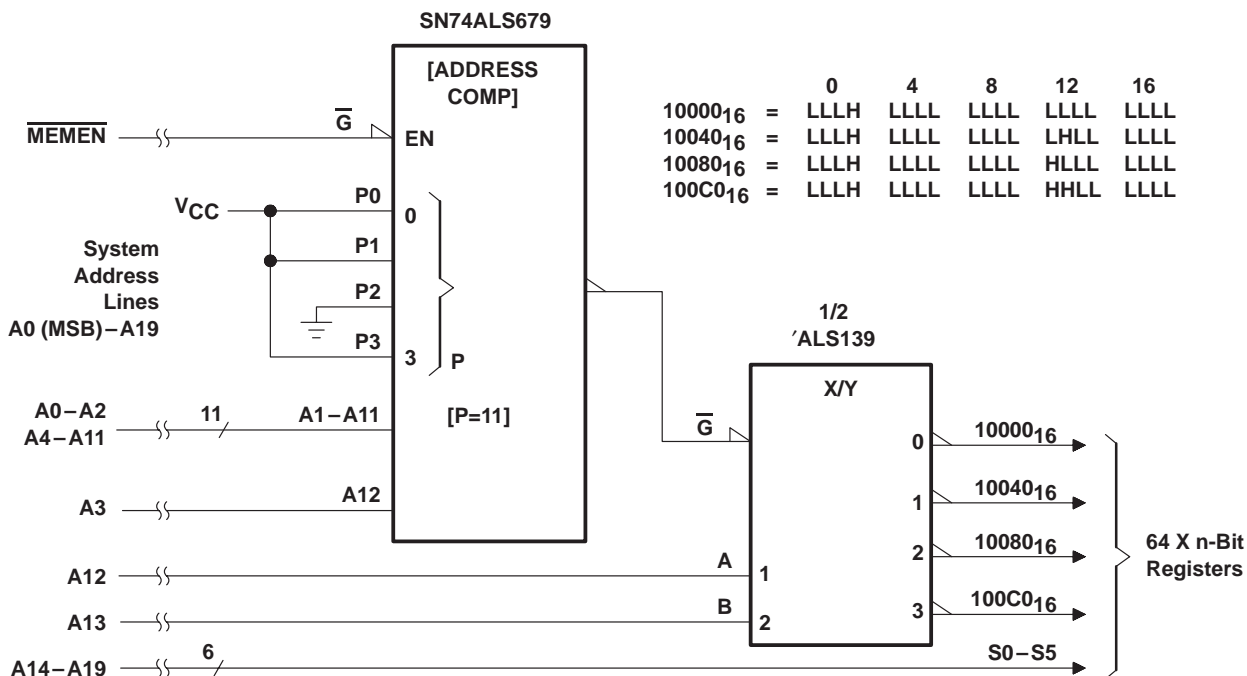


Figure 1. Register-Bank Decoder

SN74ALS679 12-BIT ADDRESS COMPARATOR

SDAS003C – JUNE 1982 – REVISED JANUARY 1995

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
 E. The outputs are measured one at a time with one transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ALS679N	NRND	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS679NE4	NRND	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBsolete: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - $\triangle D$ The 20 pin end lead shoulder width is a vendor option, either half or full width.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DLP® Products	www.dlp.com	Communications and Telecom	www.ti.com/communications
DSP	dsp.ti.com	Computers and Peripherals	www.ti.com/computers
Clocks and Timers	www.ti.com/clocks	Consumer Electronics	www.ti.com/consumer-apps
Interface	interface.ti.com	Energy	www.ti.com/energy
Logic	logic.ti.com	Industrial	www.ti.com/industrial
Power Mgmt	power.ti.com	Medical	www.ti.com/medical
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
RFID	www.ti-rfid.com	Space, Avionics & Defense	www.ti.com/space-avionics-defense
RF/IF and ZigBee® Solutions	www.ti.com/lprf	Video and Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless-apps

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2010, Texas Instruments Incorporated